

# U.S. PATENT & TRADEMARK OFFICE

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APPLICANT: Driesen et al.

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SHEET 1 OF 1

GROUP: <sup>1700</sup>Unknown



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EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB-CLASS	FILING DATE
GKG	AA	5,128,208	7/07/1992	Bond et al.	428	397	12/14/1990
GKG	AB	6,141,819	11/7/2000	Driesen et al.	15	207.2	04/01/1999
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EXAMINER:				DATE CONSIDERED: 6.2.03			

\* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.